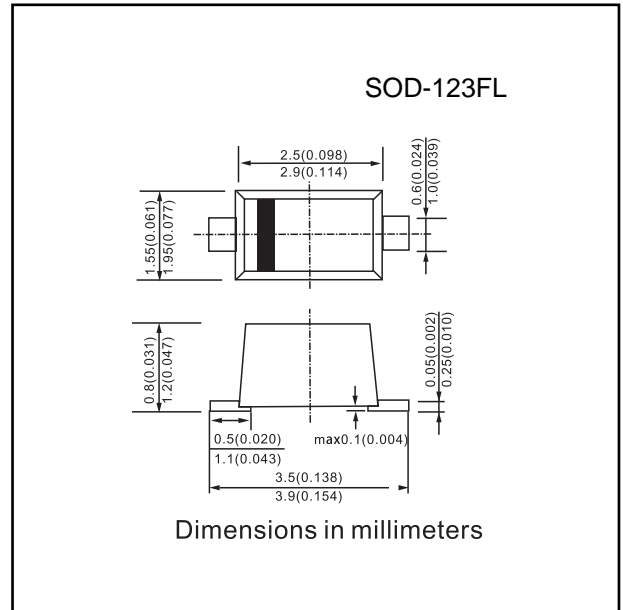


FEATURES

- Low profile package
- Ideal for automated placement
- Ultrafast reverse recovery time
- Low power losses, high efficiency
- Low forward voltage drop
- High surge capability
- High temperature soldering:
260°C/10 seconds at terminals
- Component in accordance to
RoHS 2002/95/1 and WEEE 2002/96/EC

MECHANICAL DATA

- **Case:** JEDEC SOD-123FL molded plastic body over passivated chip
- **Terminals:** Solder plated, solderable per J-STD-002B and JESD22-B102D
- **Polarity:** Laser band denotes cathode end
- **Weight:** 0.017gram



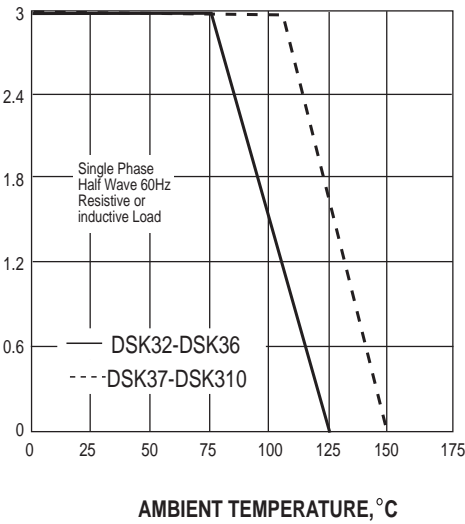
MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.
Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

MDD Catalog Number	SYMBOLS	DSK32	DSK33	DSK34	DSK35	DSK36	DSK37	DSK38	DSK39	DSK310	UNITS
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	40	50	60	70	80	90	100	VOLTS
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	49	56	63	70	VOLTS
Maximum DC blocking voltage	V _{DC}	20	30	40	50	60	70	80	90	100	VOLTS
Maximum average forward rectified current	I _(AV)	3.0									Amp
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	80.0									Amps
Maximum instantaneous forward voltage at 3.0A	V _F	0.52	0.55	0.70			0.85			Volts	
Maximum DC reverse current at rated DC blocking voltage	I _R	0.5									mA
TA=25°C TA=100°C		20.0			10.0						
Operating junction temperature range	T _J	-50 to +125					-50 to +150				°C
Storage temperature range	T _{STG}	-50 to +150									°C

AVERAGE FORWARD RECTIFIED CURRENT,
AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE



PEAK FORWARD SURGE CURRENT,
AMPERES

FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

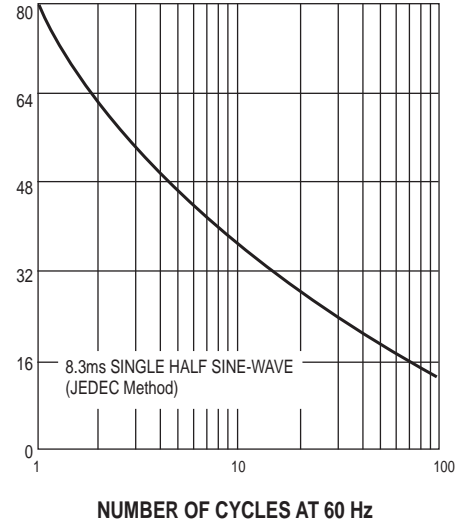


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

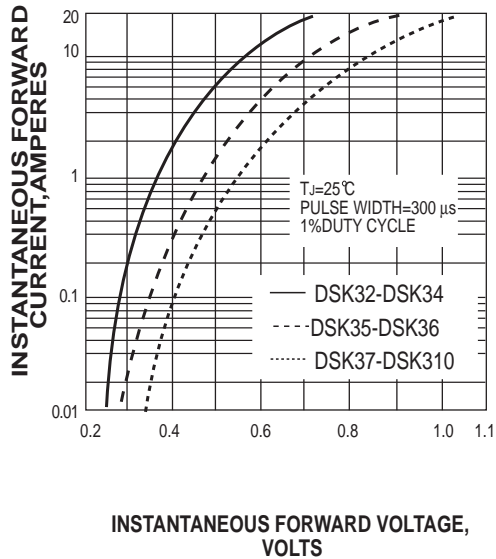


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

INSTANTANEOUS REVERSE CURRENT,
MILLIAMPERES

